Appl. No. 10/810,758
Amdt. dated November 30, 2005
Reply to Office Action of August 31, 2005

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

Claims 1-24 (Canceled)

Claim 25 (Currently amended): A method of making a probe card, said method comprising:

receiving at a ~~computer~~ local computing system over a network from a ~~prospective customer~~ remote computing system information describing a wafer to be tested;

generating ~~from said~~ at the local computing system a verification package in accordance with the information ~~a verification package comprising~~ , the verification package including at least one electronic file describing a proposed design of a probe card for testing said wafer;

electronically determining an acceptability of the proposed design; and

~~communicating over said network with said prospective customer regarding~~ transmitting to the remote computing system the acceptability of said proposed probe card design.

Claim 26 (Currently amended): The method of Claim 25, further comprising providing a graphical interface for use by ~~said prospective customer~~ the user at the remote computing system to enable input of said information describing a wafer to be tested.

Claim 27 (Previously presented): The method of Claim 26, wherein said graphical interface comprises at least one Web page.

Claim 28 (Currently amended): The method of Claim 25, further comprising ~~accepting~~ receiving at the local computing system from the remote computer system via said network an electronic order ~~from said prospective customer~~ to manufacture said proposed probe card design.

Claim 29 (Currently amended): The method of Claim 25, further comprising electronically verifying said proposed probe card design at the local computing system.

Claim 30 (Currently amended): The method of Claim 25, wherein said verification package further comprises electronic files representing drawings of said proposed probe card design.

Claim 31 (Currently amended): The method of Claim 25, wherein said communicating step the transmitting further comprises notifying said prospective customer of transmitting to the remote computing system proposed modifications to said proposed probe card design.

Claim 32 (Currently amended): The method of Claim 29, wherein [[said]] the electronic verifying [[step]] further comprises electronically simulating operation of said proposed probe card design.

Claim 33 (Currently amended): The method of Claim 29, wherein [[said] the electronically verifying [[step]] further comprises performing an automated simulation of said proposed probe card design.

Claim 34 (Currently amended): The method of Claim 29, wherein [[said]] the electronically verifying [[step]] further comprises performing a simulation based on particular specifications designated by said prospective customer.

Claim 35 (Previously presented): The method of claim 25 further comprising fabricating a probe card from said proposed probe card design.

Claims 36-53 (Canceled)